

CONTENTS

PAGE

ENPLAS SIMULATION TECHNOLOGY			③ ~ ④	
ENPLAS LONG LIFE CONTACT SOLUTION			⑤ ~ ⑥	
TEST SOCKET	HIGH FREQUENCY CONTACT PIN	BGA/CSP (Probe Pin) Type	⑦ ~ ⑬	
	STANDARD LEAD TYPE		⑰ ~ ⑱	
	QFN		⑲ ~ ⑳	
BURN-IN SOCKET				
SURFACE MOUNT TYPE	BGA/LGA	OPEN TOP	0.4, 0.5 & 0.65mm PITCH SOCKET	⑳ ~ ㉓
		CLAM-SHELL	0.4, 0.5 & 0.65mm PITCH SOCKET	㉔ ~ ㉗
	BGA	CLAM-SHELL	0.8 & 1.0mm PITCH SOCKET	㉘ ~ ㉚
THROUGH HOLE TYPE	BGA/LGA	OPEN TOP	VERSATILE SOCKET	㉛ ~ ㉜
	FBGA	OPEN TOP	0.8 & 1.0x0.8mm PITCH SOCKET	㉝ ~ ㉞
	BGA	OPEN TOP	1.0 & 1.27mm PITCH SOCKET	㉟ ~ ㊱
		CLAM-SHELL	1.27 PITCH SOCKET	㊲ ~ ㊳
	QFN	CLAM-SHELL	0.4, 0.5 & 0.65mm PITCH SOCKET	㊴ ~ ㊶
		OPEN TOP	0.5 & 0.65mm PITCH SOCKET	㊷ ~ ㊸
	QFP	OPEN TOP	0.4, 0.5, 0.65, 0.8 & 1.0mm PITCH SOCKET	㊹ ~ ㊻
		CLAM-SHELL	0.4, 0.5, 0.635, 0.65 & 0.8mm PITCH SOCKET	㊼ ~ ㊾
	SOP	OPEN TOP	0.5, 0.635, 0.65, 0.8, 1.0 & 1.27mm PITCH SOCKET	㊿ ~ ㋀
		CLAM-SHELL	0.65, 0.8, 1.0 & 1.27mm PITCH SOCKET	㋁ ~ ㋂
	TSOP	OPEN TOP	0.4, 0.5, 0.65, 0.8 & 1.27mm PITCH SOCKET	㋃ ~ ㋄
	TCP	CLAM-SHELL	0.2, 0.3 & 0.4mm PITCH SOCKET	㋅ ~ ㋆